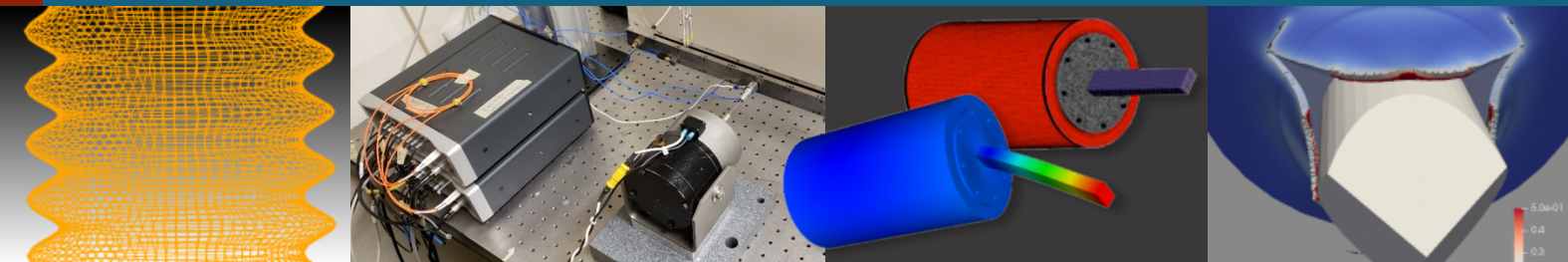


Model Validation of a Modular Foam Encapsulated Electronics Assembly With Controlled Preloads Via Additively Manufactured Silicone Lattices



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#14556

2 Presentation Overview

1. Background and Motivation
2. Experimental Methods
3. Material Modeling Strategy
4. Finite Element Modeling
5. Results
6. Conclusions and Future Work

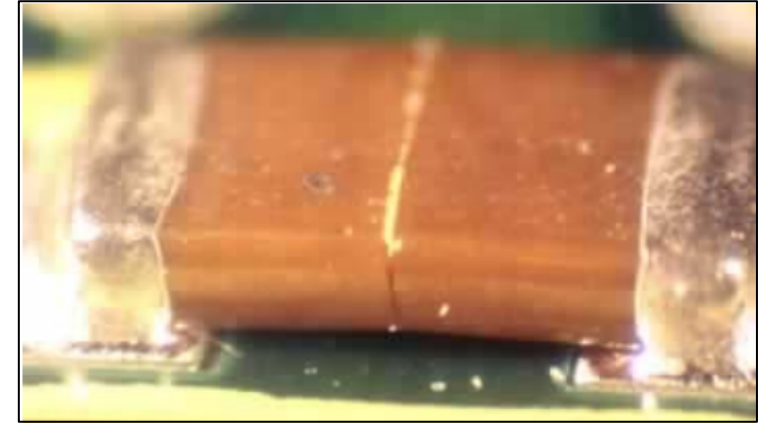


Background – vibrations of electronic assemblies

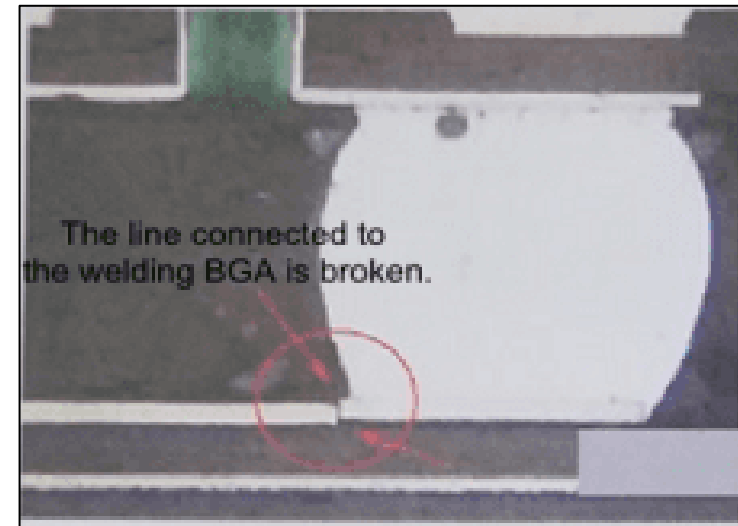


- Electronic assemblies can be exposed to harsh mechanical environmental conditions
 - Packaging is vital to ensure proper function under these conditions
- Failures resulting from demanding static (assembly) and dynamic (vibration or shock) environments include:
 - Cracking of circuit board base
 - Discontinuity of soldered connections
 - Permanent failure of strain-sensitive components (ceramic capacitors, ball grid arrays, etc.)

Modular Foam Approach: Use layers of compressed soft and rigid foams to protect the electronics by taking advantage of AM to control assembly stiffness



Broken Capacitor from Flexure [1]



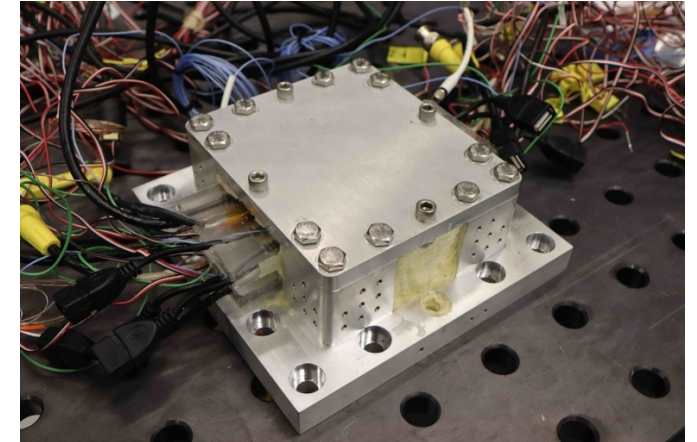
Severed Trace due to Vibrations [2]

Introduction – Foam Encapsulation Approaches

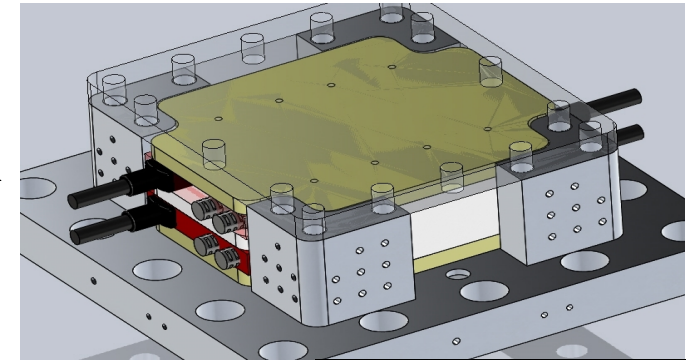


	Traditional Potted Foam	Additive Manufacturing/ Modular Approach
Overall Cost		✓
Reusability		✓
Serviceability		✓
Environment Damping	✓	✓
Mechanical Support	✓	✓
Repeatability		✓

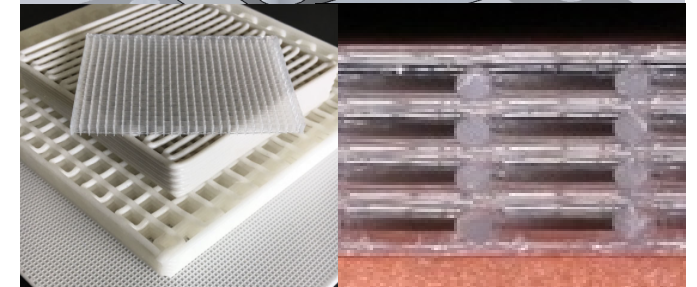
Potted Foam



Modular Foam



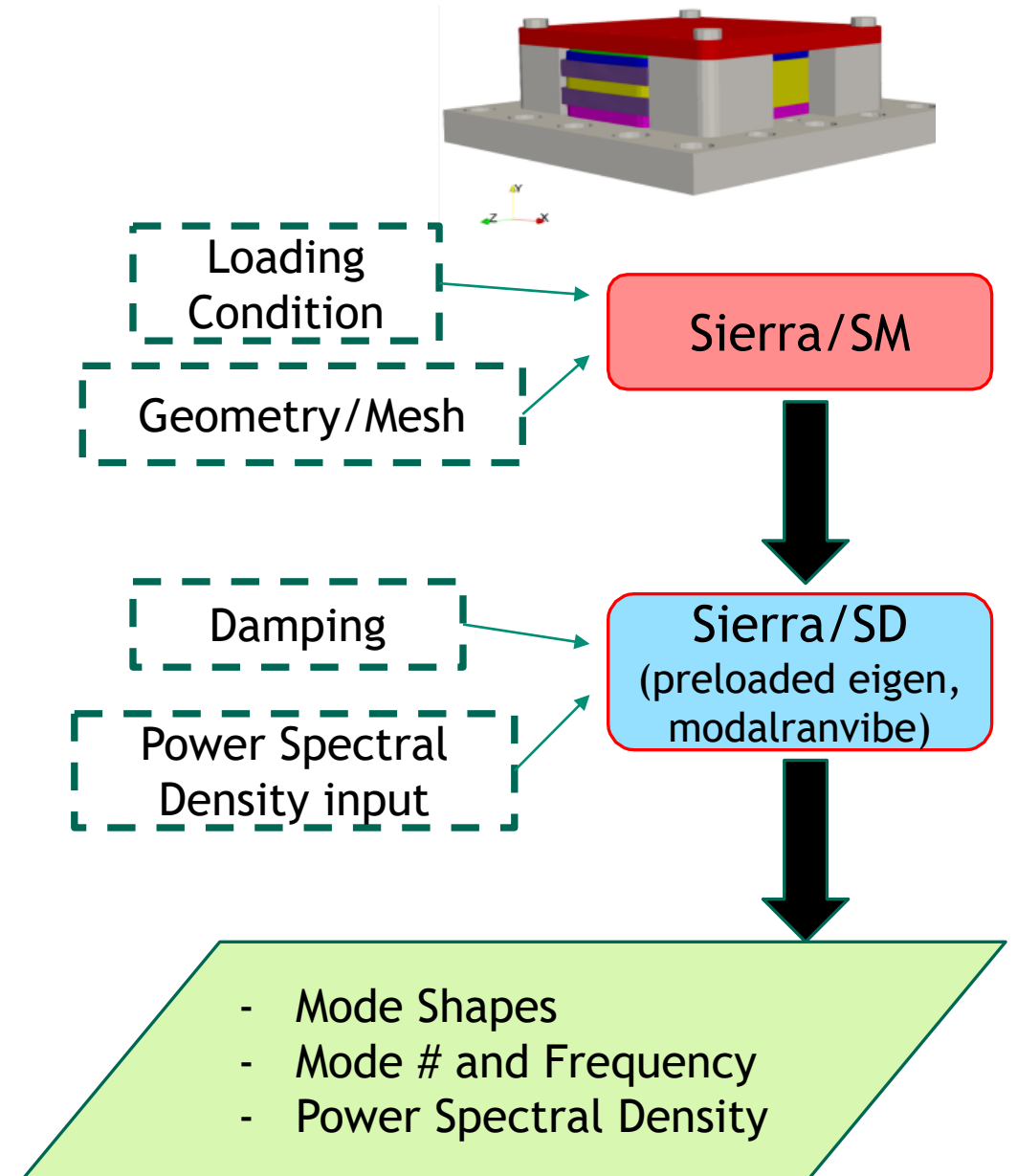
AM Lattice



AM Modular approach offers advantages- need to develop modeling strategy

Objectives

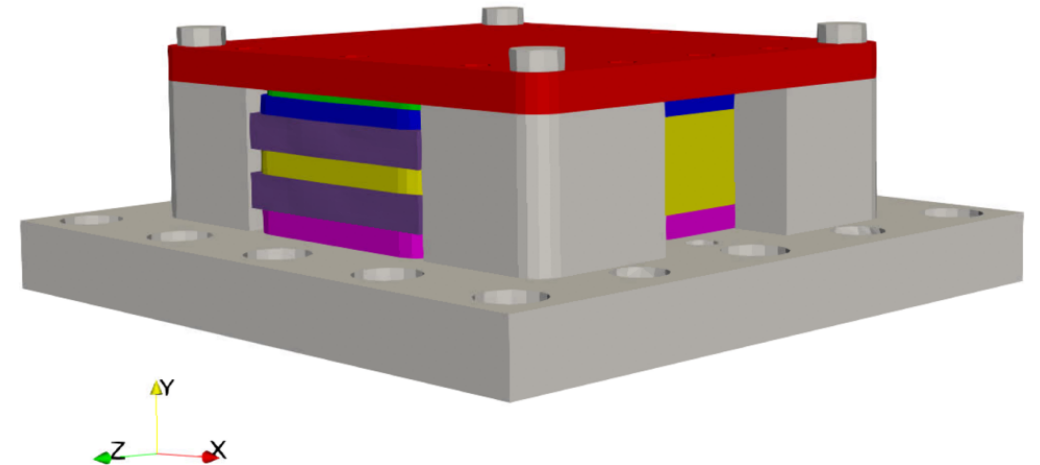
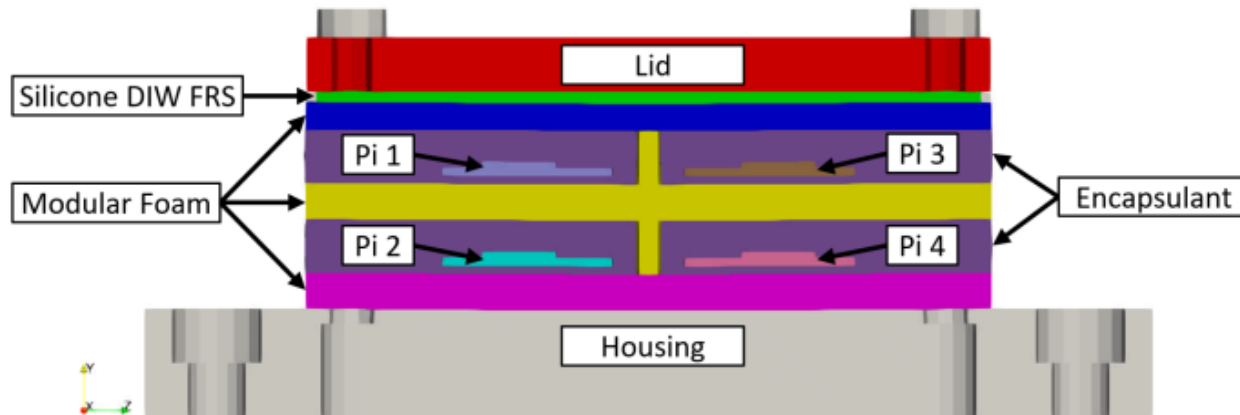
- Project Goals
 - Establish a computational model that validates modular foam experimental outcomes
 - Successfully preload the model in Sierra/Solid Mechanics and handoff the preloaded state for a modal and frequency response analysis in Sierra/Structural Dynamics
 - Investigate effects of various preloading conditions on the modal response



Geometry



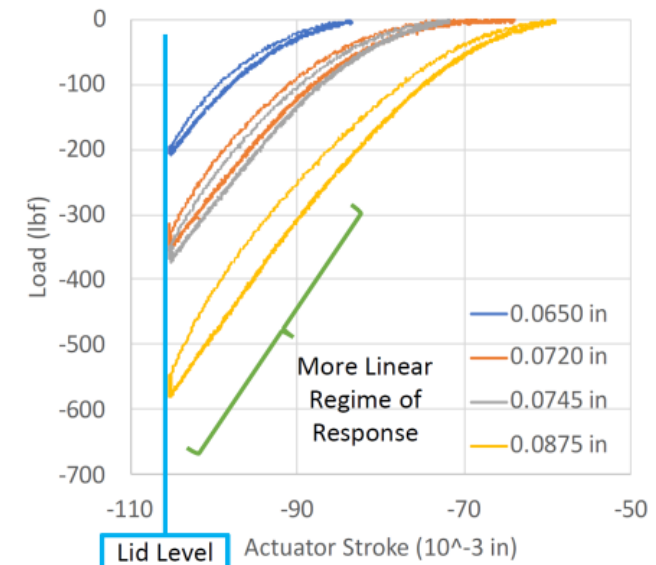
- The assembly of interest is composed of:
 - An aluminum enclosure (housing and lid)
 - Direct Ink Write (DIW) AM Lattice
 - Foam layers
 - Electronics components encapsulated by the enclosure and foams
- The assembly is roughly 7 x 7 x 4 in (17.8 x 17.8 x 10.3 cm)



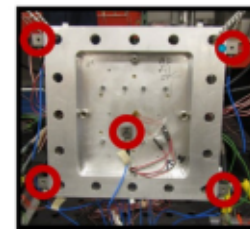
7 Experimental Methods

Tests used for model validation

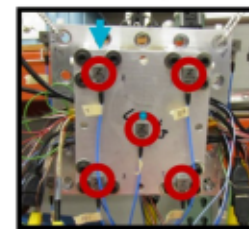
- **Load-Displacement Testing:**
 - Inform pre-compression levels for structural dynamics tests
- **Free-Free Modal Testing:**
 - Accelerometers fixed at key points
 - Experimentally measure mode frequencies and damping ratios
- **Fixed-Base Uniaxial Vibration Testing:**
 - Evaluate acceleration response of electronics
 - Unit-unit variability



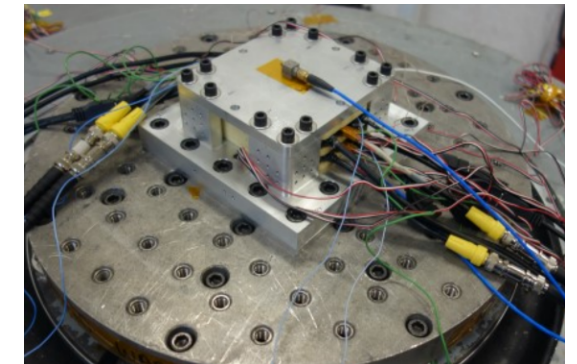
5 Accelerometers on the Bottom Plate



5 Accelerometers on the Top Plate

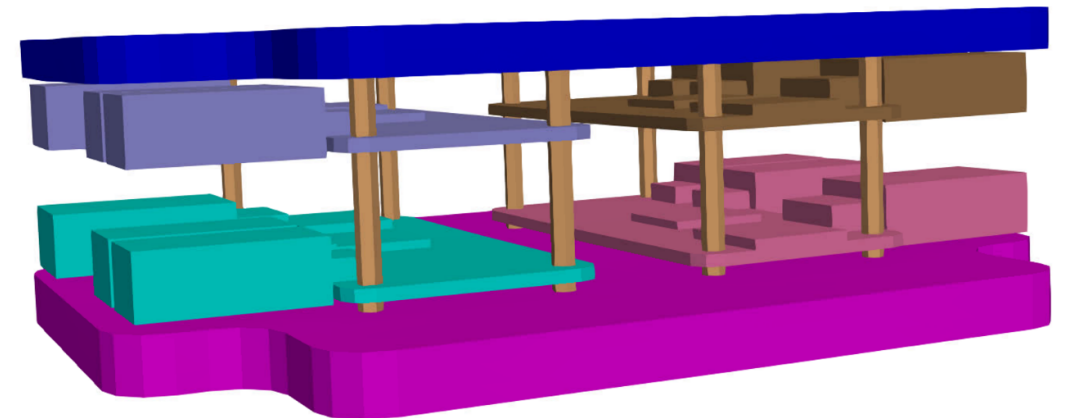
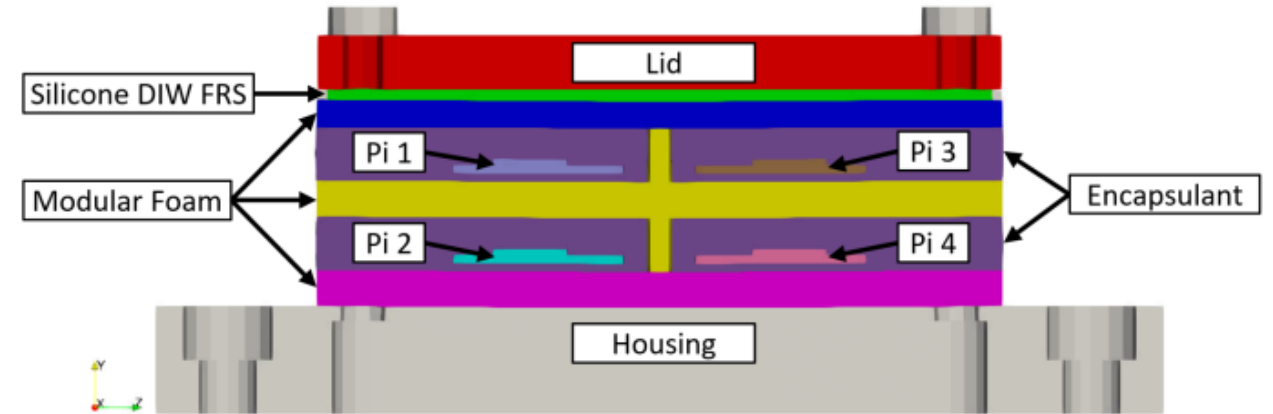


1 Accelerometer on the Raspberry Pi





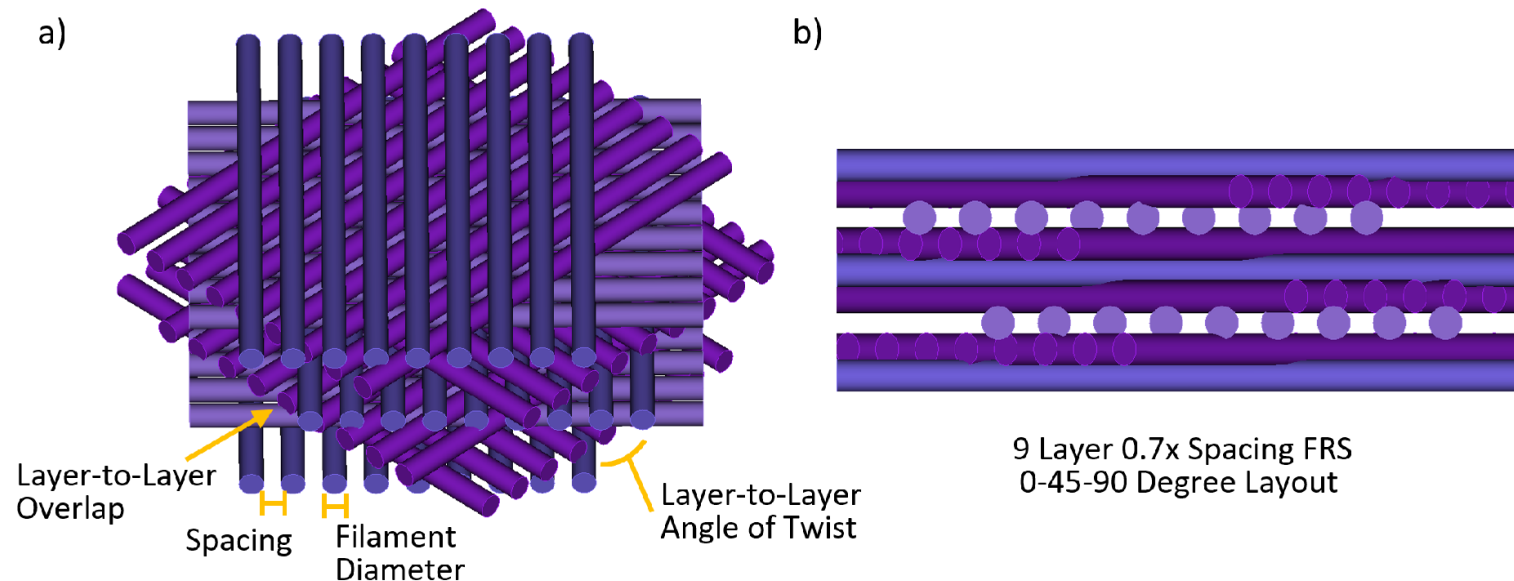
- **6061 Aluminum Lid and Housing:**
 - Linear elastic material
- **Raspberry Pi:**
 - Elastic-plastic material based on test
- **Bolts, pins, and fasteners:**
 - Linear elastic material
- **PMDI Modular Foam:**
 - Foam damage model for the solid mechanics simulation
 - Blatz-Ko model for structural dynamics simulation
- **Sylgard® 184 Encapsulant Foam:**
 - Gent model for solid mechanics
 - Neo-Hookean model for structural dynamics
- **Silicone DIW Foam Replacement Structure (FRS):**
 - Hyperfoam model based on experimental data



Homogenization of the Silicone DIW Lattice



- **Homogenization based on:**
 - Uniaxial Compression tests of Direct Ink Write (DIW) lattices
 - Parameter Estimation to fit the stress-strain response to the Hyperfoam model
- **Advantages to homogenization:**
 - Reduce model complexity
 - Reduce computational costs
 - Simple to change material parameters
 - No need to create each variation of the lattice structure



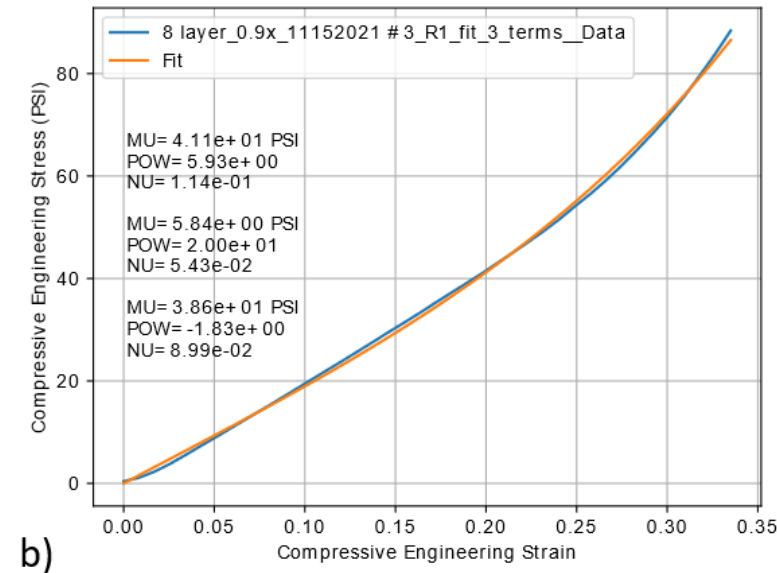
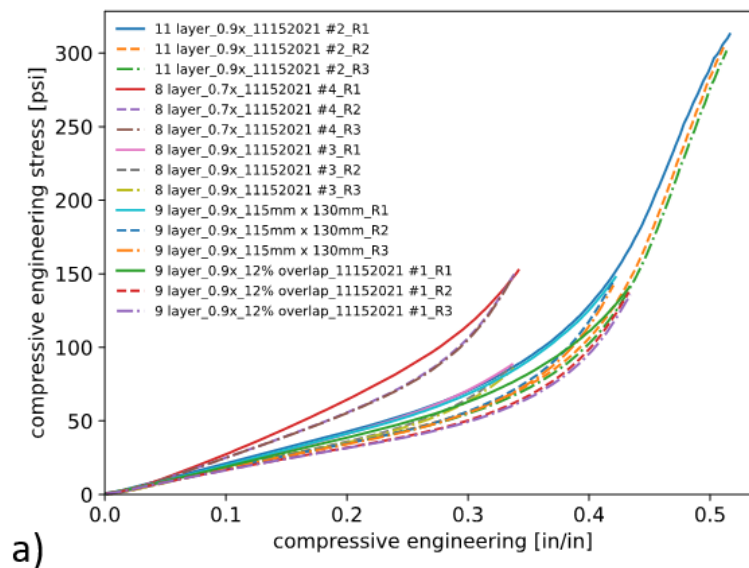
Modeling Additively Manufactured Soft Foams – Hyperfoam



Storaker (Hyperfoam) compressible hyperelastic model [3]

$$W(\lambda_1, \lambda_2, \lambda_3) = \sum_{i=1}^N \frac{2\mu_i}{\alpha_i^2} \left[\lambda_1^{\alpha_i} + \lambda_2^{\alpha_i} + \lambda_3^{\alpha_i} - 3 + \frac{1}{\beta_i} (J^{-\alpha_i \beta_i} - 1) \right]$$

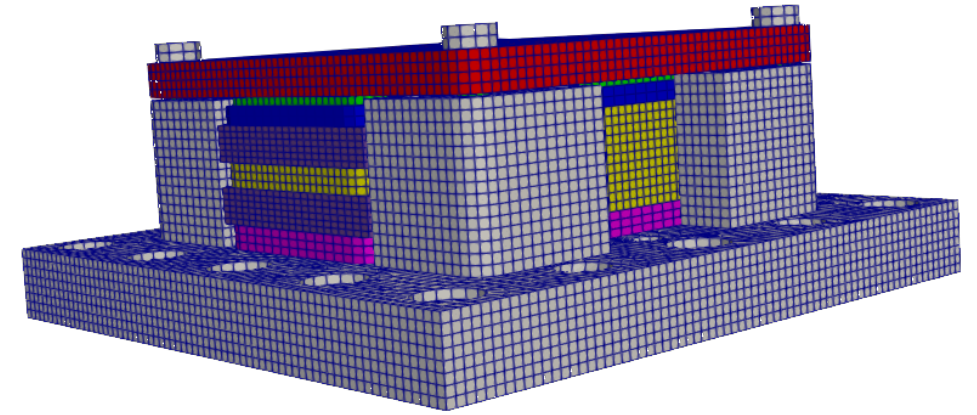
- Strain energy density dependent on principal stretch ratios (λ_k)
- Compressibility of each order: $\beta_i = v_i / (1 - 2v_i)$
- The order, N , determines how many parameters are needed
 - For each order, α_i , μ_i , and v_i need to be estimated
 - If $N = 3$, a total of 9 parameters need to be estimated
 - If $N = 1$, $\alpha_1 = -2$, $\mu_1 = \mu$, and $v_1 = 0.25$, the Blatz-Ko model is recovered



Methods – (mesh, elements, BC, Loadings)



- Quasistatic preload in Sierra/SM
- Handoff to Sierra/SD for dynamic analyses
- Mesh includes approx. 73,000
8-node Hexahedral elements (selective deviatoric)



SM Solution

- Fixed base in direction of loading
- Cosine ramp to prescribe lid displacement and compress assembly
- Artificial strain on bolts to close gap
- Temperature was fixed at 300 K

SD Solution

- Linearize preloaded state, material tangent update
- Free and fixed base for modal analysis
- Applied base acceleration for random vibration analysis



Solid Mechanics Simulations

- Computational Cost
 - Explicit time integration
 - Full model with no modifications, 12 hour sim
 - Addition of mass scaling of non critical components (base, lid)
 - After verification, sim time of 105 minutes
- Contact, Contact, Contact
 - A contact paradigm of general contact in the normal direction and friction model tangentially
 - Constraints had to be modified in order to fix contact issues
- The Handoff to SD
 - Concentrated mass at the end of rigid bar
 - Material model inconsistencies
 - Ensuring the proper state in the simulation is handed off

Structural Dynamics Simulations

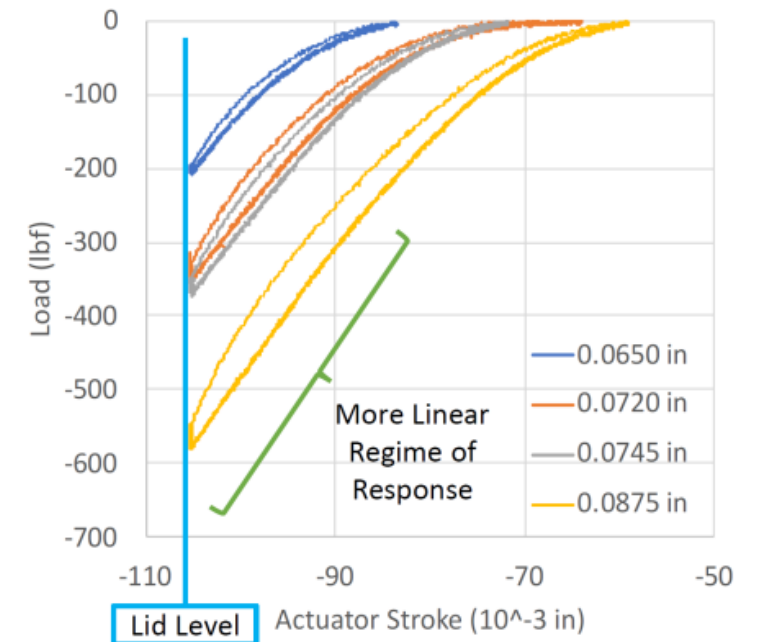
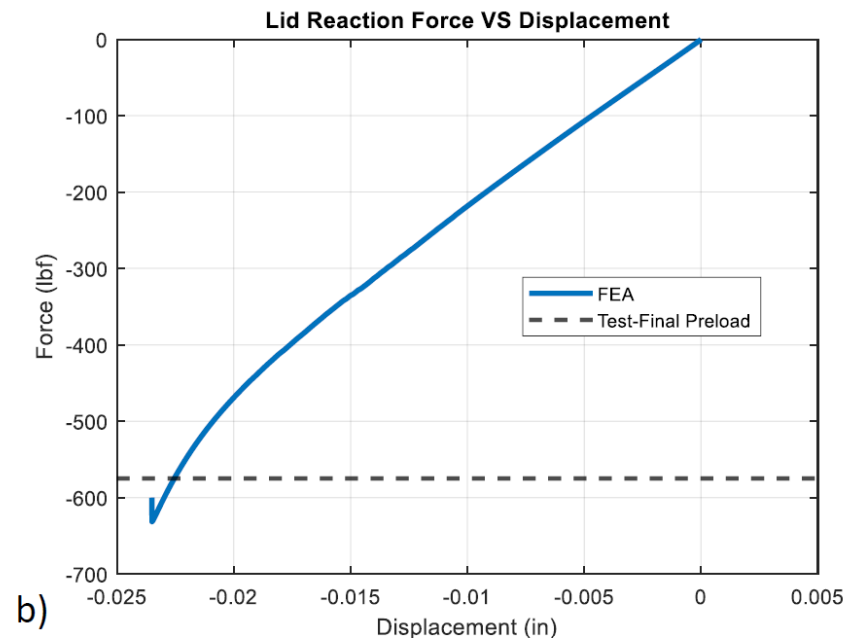
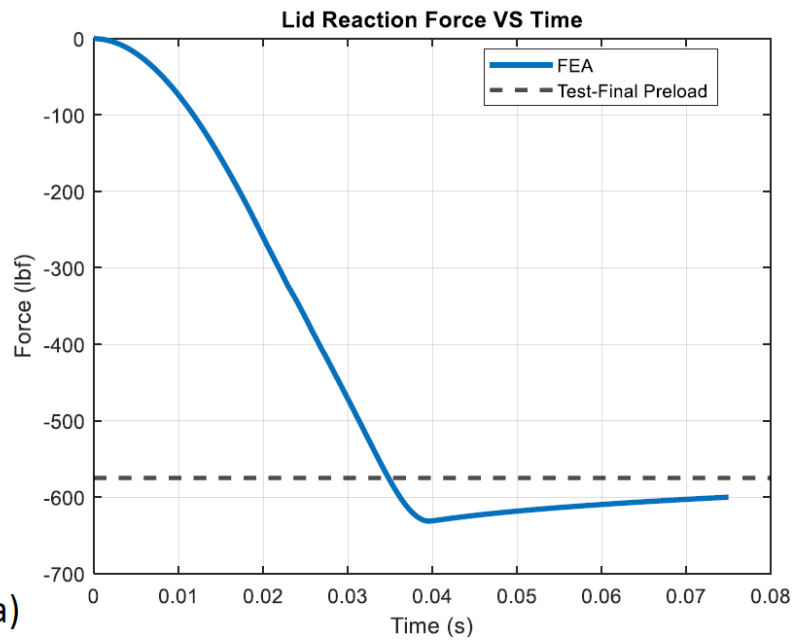
- Cases and Parameters
 - Handoff
 - Eigenfrequencies and mode shapes computed up to 3000 Hz
 - Applied acceleration amplitude of $0.01 \text{ g}^2/\text{Hz}$ modulated from 0 to 2000 Hz
 - Post processing
- Application of acceleration input
 - Concentrated mass at the end of rigid bar
 - Force applied to concentrated mass
 - Desired acceleration is applied to base
- Tuning
 - Global damping at 2%
 - First dominant mode damping at 5%
 - Second dominant mode damping at 3.25%

Results – Load-Displacement



- **Results for 0.0875 in Lattice Structure:**

- FEA result slightly over predicts the maximum load
- FEA does not consider long-time relaxation
- Results are filtered with a Butterworth filter



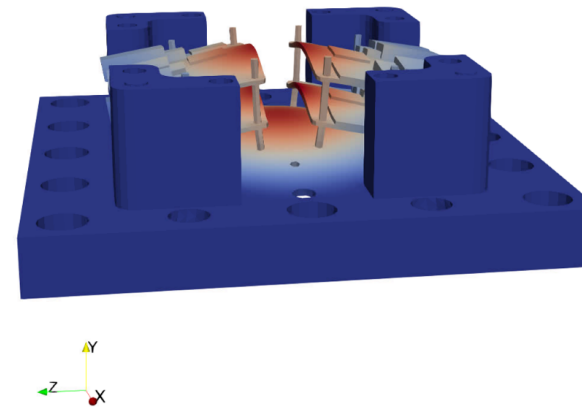
Results – Frequencies and Modes



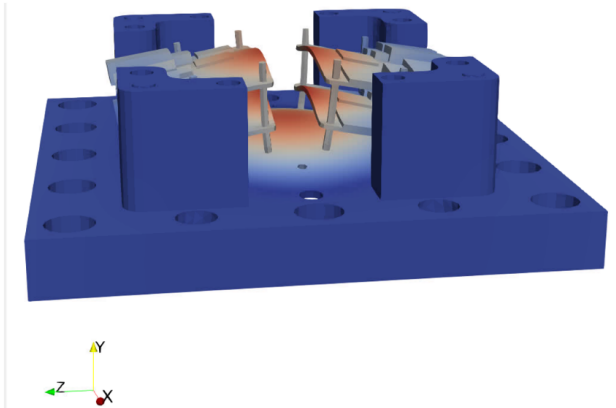
• Results for 0.0875 in Lattice Structure:

- Free-Free and Fixed-Based simulations
- Hyperelastic materials are linearized for the SD simulations
- Acceleration Response at Raspberry Pi #2 and #3 are compared to experiments
- Frequency range of interest: 0 Hz to 2,000 Hz

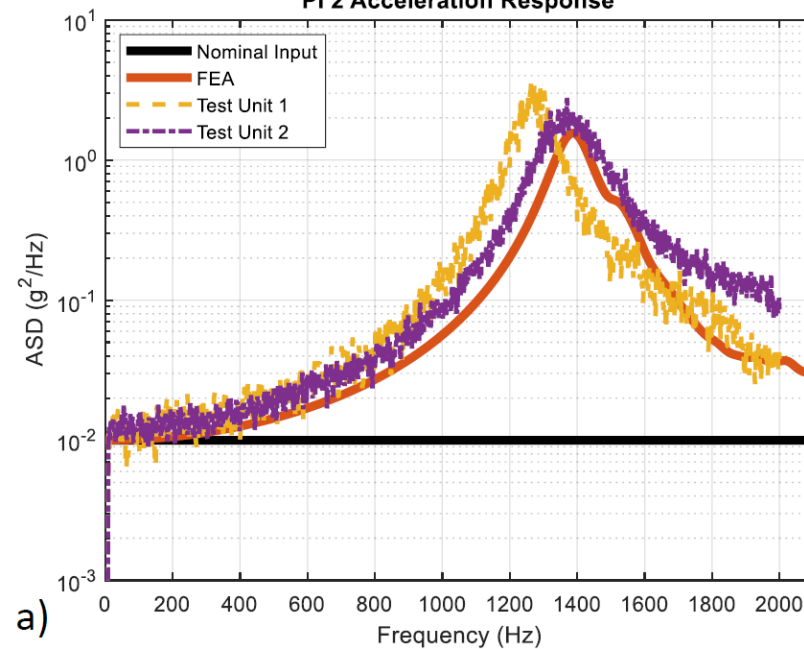
a) 1391.6 Hz



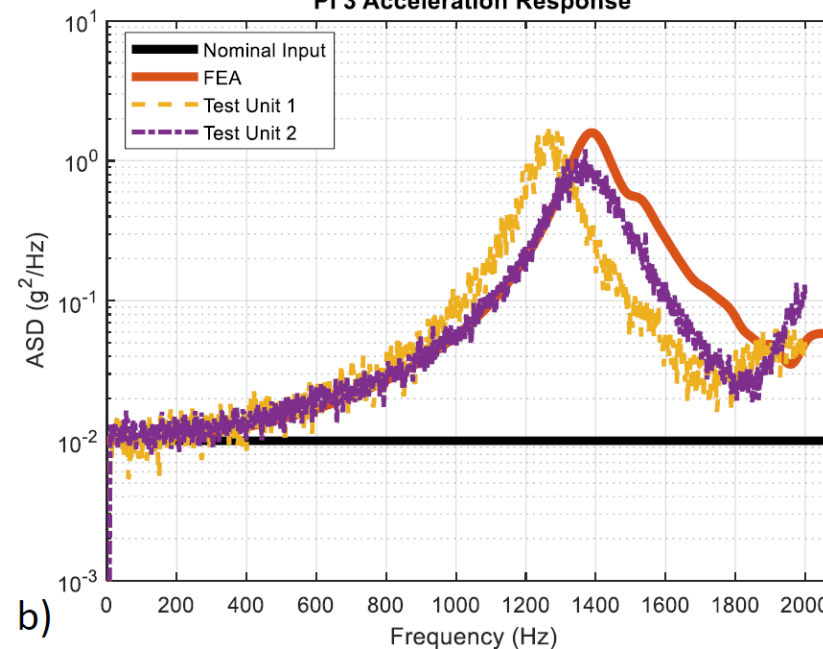
b) 1443.2 Hz



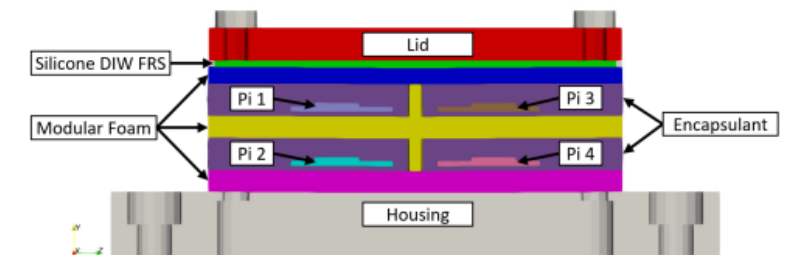
Pi 2 Acceleration Response



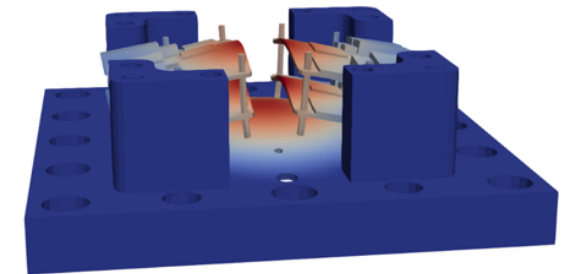
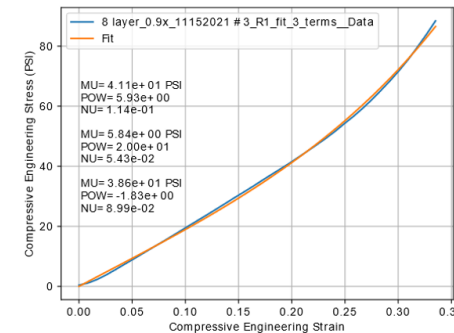
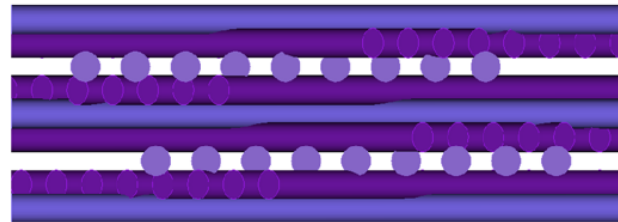
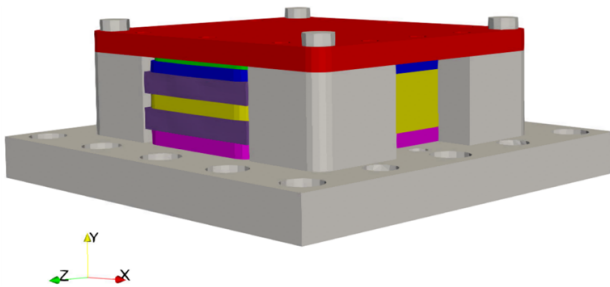
Pi 3 Acceleration Response



Unit	Free-Free Frequency (Hz)	Fixed-Base Frequency (Hz)
FE Model	1443	1392
Test Unit 1	1390	~1265
Test Unit 2	1526	~1370



- Successful validation for an analysis involving an electronics assembly consisting of modular encapsulation and AM silicone foam lattice
 - Nonlinear Sierra/SM model showed comparable load-displacement behavior to testing
 - Successful handoff to a linearized Sierra/SD model
 - SD model shows modal and vibrations results that match well with experimental data
- Future work will explore various thicknesses and designs of the lattice structure
 - Investigate the effect of varying levels of preload on the static and dynamic responses of the assembly





- [1] Roach, D. J., et al., Utilizing computer vision and artificial intelligence algorithms to predict and design the mechanical compression response of direct ink write 3D printed foam replacement structures, Additive Manufacturing, Volume 41, 2021, 101950, ISSN 2214-8604, <https://doi.org/10.1016/j.addma.2021.101950>.
- [2] Sierra Solid Mechanics Team. 2022. "Sierra/SolidMechanics 5.10 User's Guide.". United States. <https://doi.org/10.2172/1886996>. <https://www.osti.gov/servlets/purl/1886996>.
- [3] Sierra Structural Dynamics Team. "Sierra/SD - User's Manual - 5.10.". United States. <https://doi.org/10.2172/1887938>. <https://www.osti.gov/servlets/purl/1887938>.
- [4] Lame Team, Library of Advanced Materials for Engineering 5.6, SAND2022-3247, 2022.
- [5] Storakers, B. On material representation and constitutive branching in finite compressible elasticity, Journal of Mechanics and Physics of Solids, Volume 34, Issue 2, 1986, 125-145.
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- [7] Long, K. N. and Brown, J. A., A Linear Viscoelastic Model Calibration for Sylgard 184, SAND2017-4555.
- [8] Long, K. N. and Hamel, C. M., Stabilized Hyperfoam Modeling of the General Plastics EF4003 (3 PCF) Flexible Foam. SAND2022-7395R.
- [9] CUBIT Development Team, CUBIT Geometry and Mesh Generation Toolkit 15.8 User Documentation, 2021, SAND2021-5152 W.

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